

(2.54 mm) .100"

BBS, BBL, BHS, BBD, BDL SERIES

MACHINED BOARD STACKING STRIPS

Mates with:
SS, SD, HSS, SL, SDL, ESS, ESD

FEATURES

- Low profile design achieves (3.89 mm) .153" board spacings when mated with SL Series.
- Approach the reliability of a permanent connection with the flexibility of a separable connection.

SPECIFICATIONS

For complete specifications see www.samtec.com?BBS, www.samtec.com?BBL, www.samtec.com?BHS www.samtec.com?BBD or www.samtec.com?BDL

Insulator Material:
Black Liquid Crystal Polymer (BBL, BHS)
Black Glass Filled Polyester (BBS, BBD, BDL)
Temperature Range:
-55 °C to +125 °C
Terminal Material:
Phosphor Bronze or Brass
Plating:
Au or Sn over 50 µ" (1.27 µm) Ni
Lead-Free Solderable:
Yes (BBL, BDL, BHS-S)
No, Lead Wave only (BBS, BBD, BHS-N)

RECOGNITIONS

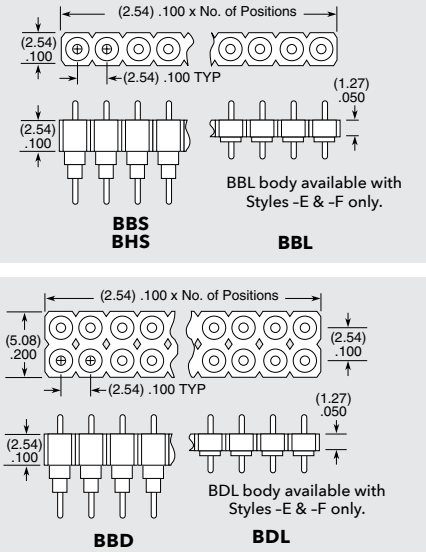
For complete scope of recognitions see www.samtec.com/quality

FILE NO. E111594

Note:
Some lengths, styles and options are non-standard, non-returnable.

TYPE STRIP	–	1	NO. PINS PER ROW	–	PLATING OPTION	–	LEAD STYLE

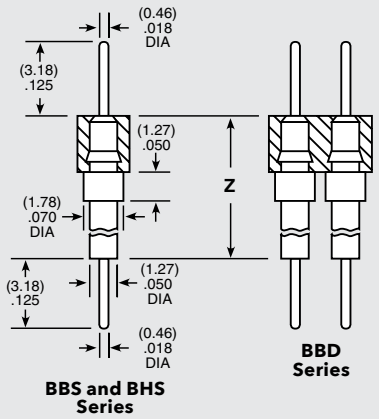
BBS = Standard Single Row
BBL = Low Profile Single Row
BHS = High Temp Single Row
BBD = Standard Double Row
BDL = Low Profile Double Row

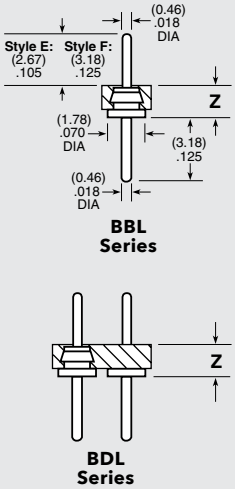


-G = 20 µ" (0.51 µm) Gold
-T = Tin

01 thru 32 = BBS & BBL
01 thru 36 = BBD, BDL & BHS

-A	-B	-C	-E	-F
Z = (5.33 mm) .210"	Z = (8.51 mm) .335"	Z = (14.86 mm) .585"	Z = (1.78 mm) .070"	Z = (2.16 mm) .085"





Unless otherwise approved in writing by Samtec, all parts and components are designed and built according to Samtec's specifications which are subject to change without notice.